

ABSTRACT

THIS SHEET HAS BEEN
REPLACED

Electronic components, chips, are moulded in a single-strip moulding apparatus. The products to be moulded are placed in a mould consisting of two halves, one of the halves whereof displays recesses for receiving a component, 5 which half is connected via a channel with a cavity for receiving a quantity of moulding material.

For exerting pressure on the moulding material in the recesses a plunger which is driven by means of an electromotor, a screwed rod and a nut arranged on the 10 screwed rod is used.

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